

SILICON SWITCHING DIODE 1SS304

HIGH SPEED SWITCHING SILICON EPITAXIAL DOUBLE DIODE : COMMON CATHODE

FEATURES

- Low capacitance: Ct = 1.1 pF TYP.
- High speed switching: trr = 3.0 ns MAX.
- Wide applications including switching, limitter, clipper.
- Double diode configuration assures economical use.

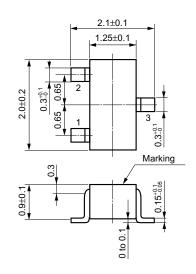
ABSOLUTE MAXIMUM RATINGS

Maximum Voltages and Currents (T_A = 25°C)

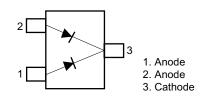
	Peak Reverse Voltage	V_{RM}	75	V	
	DC Reverse Voltage	V_{R}	50	V	
	Surge Current (1 μs) Note	IFSM	6.0	Α	
	Surge Current (1 µs)	IFSM	4.0	Α	
	Peak Forward Current Note	I FM	450	mA	
	Peak Forward Current	Iғм	300	mA	
	Average Rectified Current Note	lo	150	mA	
	Average Rectified Current	lo	100	mA	
Maximum Temperatures					
	Junction Temperature	T_j	150	°C	
	Storage Temperature Range	T _{stg}	-55 to + 150	°C	
Thermal Resistance					
	Junction to Ambient Note	Rth(j-a)	1.0	°C/mW	
	Junction to Ambient	$R_{th(j-a)}$	0.85	°C/mW	

Note Both diodes loaded simultaneously.

PACKAGE DIMENSIONS (Unit: mm)



CONNECTION DIAGRAM (Top View)



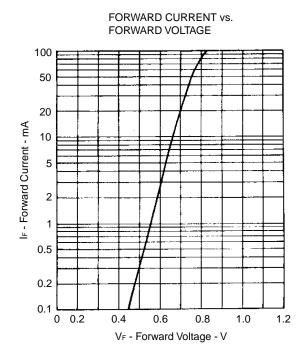
Marking: A6

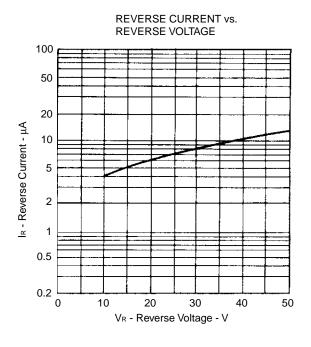
ELECTRICAL CHARACTERISTICS (TA = 25°C)

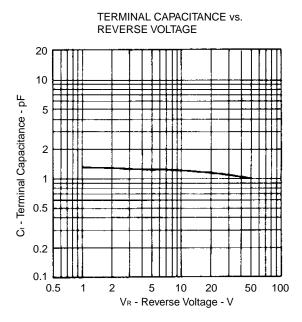
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Forward Voltage	V _{F1}	I _F = 10 mA		0.67	1.0	V
	V _{F2}	I _F = 50 mA		0.75	1.1	V
	V _{F3}	IF = 100 mA		0.85	1.2	V
Reverse Current	lR	V _R = 50 V			0.1	μА
Capacitance	Ct	$V_R = 0 V$, $f = 1.0 MHz$		1.1	4.0	pF
Reverse Recovery Time	trr	See Test Circuit.			3.0	ns

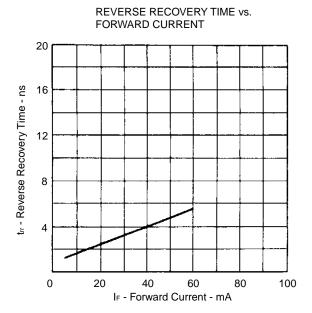
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TYPICAL CHARACTERISTICS (TA = 25°C)



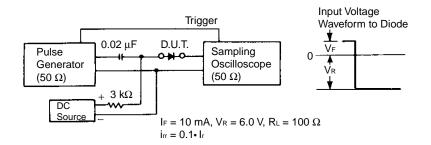


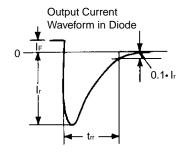






REVERSE RECOVERY TIME (trr) TEST CIRCUIT





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